

**SS10150**

**10.0AMPS. SCHOTTKY BARRIER RECTIFIERS**

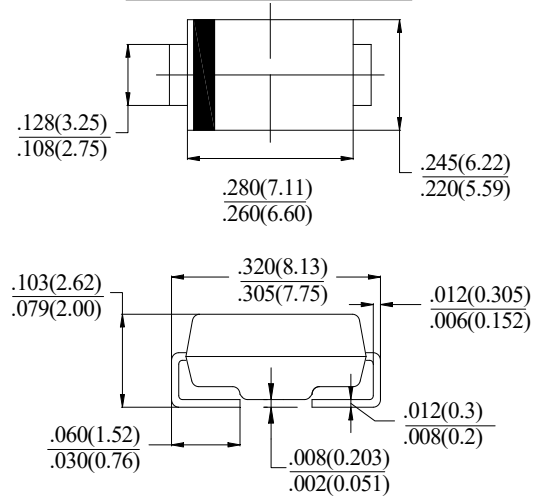
**FEATURE**

- . For surface mounted application
- . High current capability
- . Low forward voltage drop
- . Low power loss, high efficiency
- . High surge current capability
- . High temperature soldering guaranteed:  
260°C/10 seconds at terminals.
- . For surface mounted application.
- . Easy pick and place.

**MECHANICAL DATA**

- . Terminal: Solder plated
- . Case: Molded with UL-94 Class V-0 recognized  
Flame Retardant Epoxy
- . Polarity: color band denotes cathode

**SMC (DO-214AB)**



Dimensions in inches and (millimeters)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

<b>MAXIMUM RATINGS</b> ( $T_C=25^\circ\text{C}$ unless otherwise noted)			
Parameter	SYMBOL	SS10150	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	150	V
Maximum RMS Voltage	$V_{RMS}$	105	V
Maximum DC blocking Voltage	$V_{DC}$	150	V
Average Forward Rectified Current	$I_{F(AV)}$	10.0	A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	$I_{FSM}$	150	A
Typical Junction Capacitance (Note1)	$C_J$	200	pF
Storage Temperature	$T_{STG}$	-55 to + 150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-55 to + 150	$^\circ\text{C}$

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_C=25^\circ\text{C}$ unless otherwise noted)					
Parameter	SYMBOL	Min	Typ	Max	Units
Reverse Breakdown Voltage at $I_r=0.20\text{mA}$	$V_{BR}$	150	-----	-----	V
Instantaneous Forward voltage at 10A	$V_F$	-----	0.82	0.95	V
Instantaneous Forward voltage at 2A	$V_F$	-----	0.68	0.72	V
Reverse current at rated DC blocking voltage	$I_R$	-----	-----	5.0	uA
		-----	50.0	200.0	

<b>THERMAL CHARACTERISTICS</b> ( $T_C=25^\circ\text{C}$ unless otherwise noted)			
Parameter	SYMBOL	SS10150	Units
Typical Thermal Resistance (Note2)	$R_{(JA)}$ $R_{(JC)}$	55 15	$^\circ\text{C}/\text{W}$

**Note:**

1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
2. Measured on P.C.Board with 15.0mm\*15.0mm\*1.6mm Copper Pad Areas

## Rating and Characteristic Curves

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

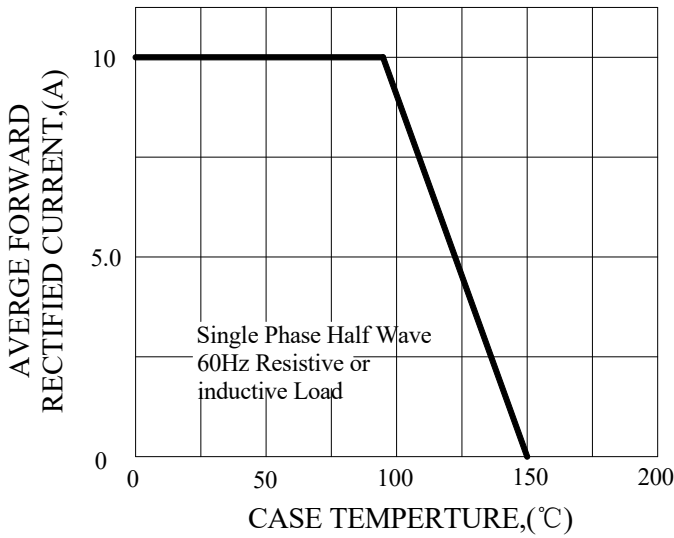


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

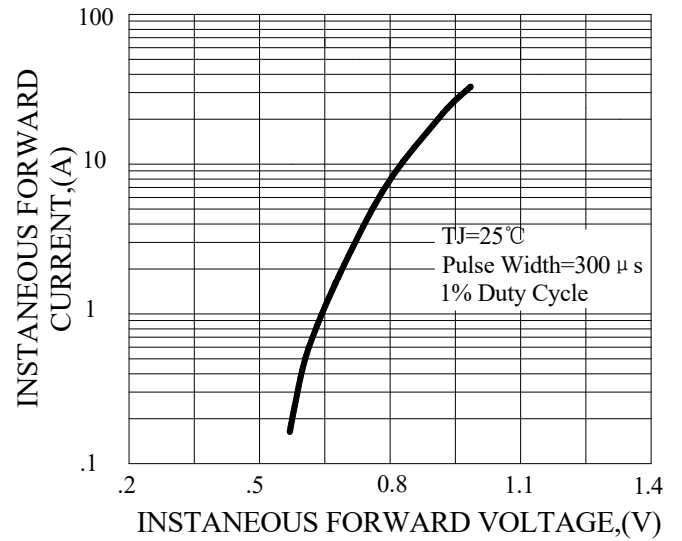


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

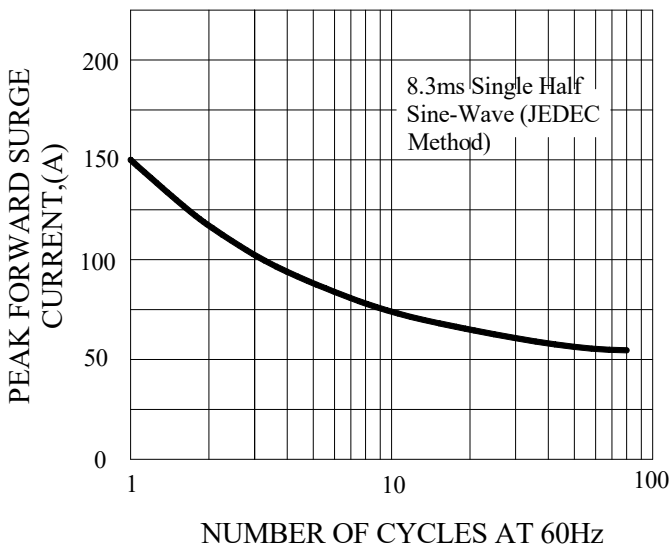
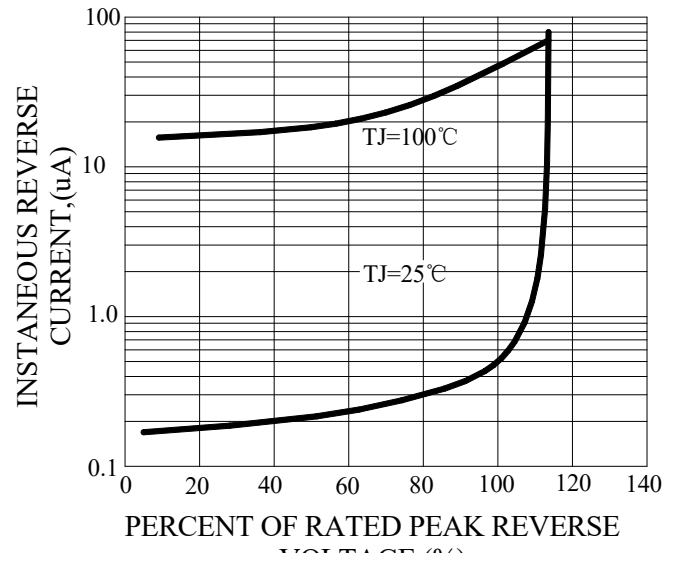
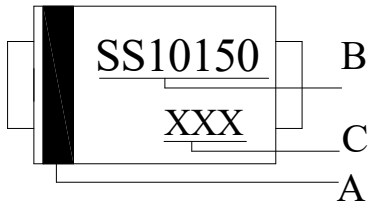


FIG.4-TYPICAL REVERSE CHARACTERISTICS



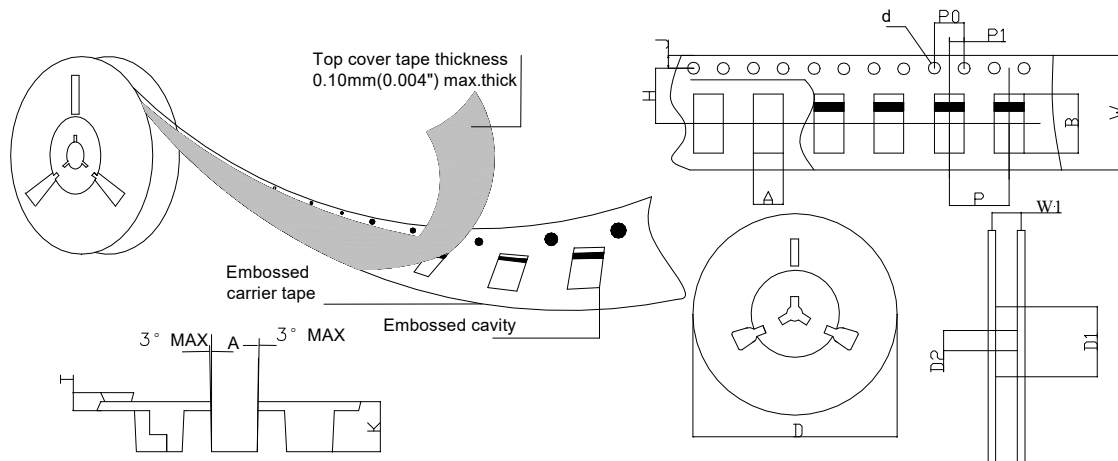
## Marking 、 Packaging Illustration

### 1、 Marking



SYMBOL	Explanation
A	Color Band Denotes Cathode
B	Product name
C	Date Code

### 2、 Packaging



SPECIFICATIONS mm(inch)		PACKAGE	SPECIFICATIONS mm(inch)		PACKAGE
ITEM	SYM BOL	SMC (DO-214AB)	ITEM	SYM BOL	SMC (DO-214AB)
Carrier width	A	6.15(0.242)Max	Carrier depth	K	2.54(0.100)Typ
Carrier length	B	8.41(0.331)Max	Punch hole pitch	P	8.00(0.315)Typ
Sprocket hole	d	ø1.55(0.061)Typ	Sprocket hole pitch	P0	4.00(0.157)Typ
Reel outer diameter	D	330.0(13.0)Typ	Embossment center	P1	2.00(0.079)Typ
Reel inner diameter	D1	74.0(2.913)Min	Overall tape thickness	T	0.25(0.010)Typ
Feed hole diameter	D2	13.0(0.512)Typ	Tape width	W	16.0(0.430)Typ
Sprocket hole position	J	1.75(0.069)Typ	Reel width	W1	16.5(0.650)Min
Punch hole position	H	7.50(0.295)Typ			